

Application Data Sheet

Application Information

Application number::	Not Yet Assigned
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	SEMICONDUCTOR LASER ASSEMBLY
Attorney Docket Number::	204552030600
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	1
Total Drawing Sheets::	6
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Nobuhiro
Family Name::	NISHIYAMA
City of Residence::	Habikino-shi
Country of Residence::	Japan
Street of mailing address::	1-12-3-403, Nishiura,
City of mailing address::	Habikino-shi
State or Province of mailing address::	Osaka-fu
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Kenichi
Family Name:: KURITA
City of Residence:: Kitakatsuragi-gun
Country of Residence:: Japan
Street of mailing address:: 192-1-215, Hajikami, Shinjo-cho
City of mailing address:: Kitakatsuragi-gun
State or Province of mailing address:: Nara-ken
Country of mailing address:: Japan
Postal or Zip Code of mailing address::

Correspondence Information

Correspondence Customer Number:: 25227

Representative Information

Representative Customer Number:: 25227

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-313970	10/29/02	Yes

Assignee Information

Assignee name:: Sharp Kabushiki Kaisha
City of mailing address:: Osaka-shi, Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 545-8522